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June 2011

## FAN7314A — LCD Backlight Inverter Drive IC

#### **Features**

- High-Efficiency Single-Stage Power Conversion
- Wide Input Voltage Range: 6V to 25.5V
- Backlight Lamp Ballast and Soft Dimming
- Minimal Required External Components
- Precision Voltage Reference Trimmed to 2%
- ZVS Half-Bridge Topology
- Soft-Start
- PWM Control at Fixed Frequency
- Analog and Burst Dimming Function
- Programmable Striking Frequency
- Open-Lamp Protection
- Open-Lamp Regulation
- Thermal Shutdown
- 20-Pin SOIC

## **Applications**

- LCD TV
- LCD Monitor

### Description

The FAN7314A provides all the control functions for a series parallel resonant converter as well as a pulse width modulation (PWM) controller to develop a supply voltage. Typical operating frequency range is between 30kHz and 250kHz, depending on the CCFL and the transformer's characteristics.

The FAN7314A is available in a 20-SOIC package.



## **Ordering Information**

Part Number	Package	Operating Temperature	Packing Method
FAN7314AM	20-SOIC	-25 to +85°C	RAIL
FAN7314AMX	20-SOIC	-25 to +85°C	TAPE & REEL

## **Important Note:**

For complete performance specifications, please contact one of the following:

	·	•	
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## **Block Diagram**

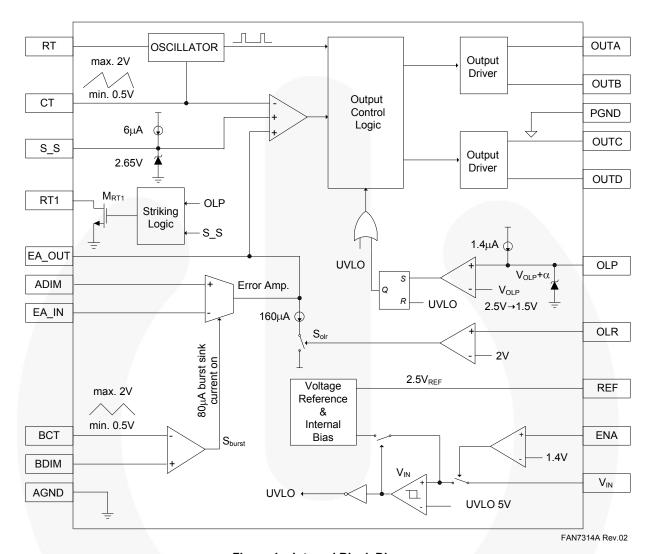


Figure 1. Internal Block Diagram

#### **Pin Configuration** OLP 20 RT1 OLR OUTB 19 ENA OUTA AN7314A 18 s\_s 17 $V_{IN}$ GND **PGND** 16 REF OUTC 15 ADIM OUTD 14 **BDIM** CT 13 EA\_IN RT 12 EA\_OUT 11 **BCT**

F: Fairchild logo

**P**: Assembly site code **XY**: Year & weekly code

TT: Die run code

FAN7314A: Device name

Figure 2. Package Diagram

## Pin Definitions

Pin#	Name	Description
1	OLP	<b>Open-Lamp Protection</b> . Typically, a capacitor is connected to this pin from the ground. The capacitor is charged by the $1.4\mu A$ internal current source and when its voltage is more than $2.5V$ the IC enters into the shutdown mode.
2	OLR	Open-Lamp Regulation. If the voltage of the OLR pin is more than 2V, the voltage of the EA_OUT pin voltage will be discharged by the 160μA internal current source.
3	ENA	Enable. Turns on/off the IC.
4	S_S	<b>Soft-Start</b> . Typically, a capacitor is connected to this pin from the ground. The capacitor is charged by the $6\mu A$ internal current source. Soft start operation is working while the S_S pin voltage is less than the EA_OUT pin voltage.
5	GND	Ground. Control block.
6	REF	Reference. 2.5V reference output.
7	ADIM	<b>Analog Dimming</b> . This pin is the input for positive polarity. The lamp current decreases with decreasing this pin voltage.
8	BDIM	<b>Burst Dimming</b> . This pin is the input for negative polarity. The voltage range of 0.5 to 2V at this pin controls burst mode duty cycle from 0% to 100%.
9	EA_IN	Error Amplifier Inverting Input. This pin voltage is regulated at ADIM voltage.
10	EA_OUT	<b>Error Amplifier Output</b> . Typically, a compensation capacitor is connected to this pin from the ground.
11	ВСТ	<b>Burst Timing Capacitor</b> . This pin is for programming the frequency of the burst dimming. Typically, a capacitor is connected to this pin from the ground. The BCT frequency increases with decreasing its capacitance.
12	RT	<b>Timing resistor</b> . This pin is for programming the switching frequency. Typically, a resistor is connected to this pin from the ground. The switching frequency increases with decreasing its resistance.
13	СТ	<b>Timing Capacitor</b> . This pin is for programming the switching frequency. Typically, a capacitor is connected to this pin from the ground. The switching frequency increases with decreasing its capacitance.
14	OUTD	NMOS Gate-Drive Output.
15	OUTC	PMOS Gate-Drive Output.
16	PGND	Power Ground.
17	VIN	Supply Voltage.
18	OUTA	PMOS Gate-Drive Output.
19	OUTB	NMOS Gate-Drive Output.
20	RT1	<b>Striking Timing Resistor</b> . Typically, a resistor is connected to this pin from the RT pin. The striking frequency increases with decreasing its resistance.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V <sub>IN</sub>	IC Supply Voltage	6	25.5	V
T <sub>A</sub>	Operating Temperature Range	-25	+85	°C
TJ	Operating Junction Temperature		+150	°C
T <sub>STG</sub>	Storage Temperature Range	-65	+150	°C
$\theta_{JA}$	Thermal Resistance Junction-Air <sup>(1,2)</sup>		90	°C/W
$P_D$	Power Dissipation		1.4	W

#### Notes:

- 1. Thermal resistance test board. Size: 76.2mm x 114.3mm x 1.6mm (1S0P); JEDEC standard: JESD51-2, JESD51-3.
- 2. Assume no ambient airflow.

### Pin Breakdown Voltage

Pin#	Name	Value	Unit	Pin #	Name	Value	Unit
1	OLP	7		11	BCT	7	
2	OLR	7		12	RT	7	
3	ENA	7		13	CT	7	
4	S_S	7		14	OUTD	10.5	
5	GND	7	V	15	OUTC	25.5	V
6	REF	7	V	16	PGND	7	V
7	ADIM	7		17	VIN	25.5	
8	BDIM	7		18	OUTA	25.5	
9	EA_IN	7		19	OUTB	10.5	
10	EA_OUT	7		20	RT1	7	

### **Electrical Characteristics**

For typical values,  $T_A$  = 25°C,  $V_{IN}$  = 12V, and -25°C  $\leq$   $T_A \leq$  85°C, unless otherwise specified. Specifications to -25°C  $\sim$  85°C are guaranteed by design based on final characterization results.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
REFERENC	E SECTION (Recommended X7R Cap	pacitor)				
$\Delta V_{ref}$	Line Regulation	$5 \leq V_{IN} \leq 25.5V$		2	25	mV
V <sub>25</sub>	2.5V Regulation Voltage		2.45	2.5	2.55	V
OSCILLATO	OR SECTION (MAIN)			•		
f <sub>OSC</sub>	Oscillation Frequency	$T_A$ =25°C, CT=270pF, RT=18k $\Omega$	110.4	115.0	119.6	kHz
	. ,	CT=270pF, RT=18kΩ	108	115	122	
$V_{cth}$	CT High Voltage			2.0		V
$V_{\text{ctl}}$	CT Low Voltage			0.5		V
OSCILLATO	OR SECTION (BURST)					
f <sub>oscb</sub>	Oscillation Frequency	$T_A$ =25°C, $C_{tb}$ =10nF, RT=18k $\Omega$	195	220	246	Hz
	. ,	C <sub>tb</sub> =10nF, RT=18k $\Omega$	191	220	249	
$V_{\text{bcth}}$	BCT High Voltage			2		V
$V_{\text{bctl}}$	BCT Low Voltage			0.5		V
ERROR AM	PLIFIER SECTION					
G <sub>m</sub>	Error Amplifier Trans-conductance	EA_OUT=1V, ADIM=1V	100	360	600	umho
A <sub>v</sub>	Error Amplifier Open-loop Gain <sup>(3)</sup>			50		dB
V <sub>eh</sub>	EA_OUT Clamping Voltage		2.3	2.7	3.0	V
I <sub>sin</sub>	Output Sink Current	ADIM=1V, EA_IN=2V	35	70	105	μA
I <sub>sur</sub>	Output Source Current	ADIM=1V, EA_IN=0V	-154	-110	-66	μA
l <sub>olr</sub>	EA_OUT Sink Current on OLR	OLR>2.5V	-210	-160	-110	μA
I <sub>burst</sub>	EA_OUT Sink Current on Burst Dimming		-100	-80	-60	μA
SOFT-STAF	RT SECTION					
$I_{SS}$	Soft-Start Current	S_S=1V	4	6	8	μA
$V_{ssh}$	Soft-Start Clamping Voltage		2.3	2.65	3.00	V
PROTECTIO	ON SECTION					
V <sub>olp0</sub>	Open-Lamp Protection Voltage 0	Start at open lamp	2.2	2.5	2.8	V
V <sub>olp1</sub>	Open-Lamp Protection Voltage 1	Normal -> open lamp	1.3	1.5	1.7	V
V <sub>olr</sub>	Open-Lamp Regulation Voltage		1.75	2.00	2.25	V
l <sub>olp</sub>	Open-Lamp Protection Charging Current		0.7	1.4	2.1	μΑ

#### Note:

3. These parameters, although guaranteed, are not 100% tested in production.

## **Electrical Characteristics** (Continued)

For typical values,  $T_A$  = 25°C,  $V_{IN}$  = 15V, and -25°C  $\leq$   $T_A \leq$  85°C, unless otherwise specified. Specifications to -25°C  $\sim$  85°C are guaranteed by design based on final characterization results.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
UNDER VOL	TAGE LOCK OUT SECTION					
$V_{th}$	Start Threshold Voltage				5	V
I <sub>st</sub>	Start-up Current	V <sub>IN</sub> =V <sub>th</sub> -0.2		130	180	μA
I <sub>op</sub>	Operating Supply Current	V <sub>IN</sub> =12V		1.5	4.0	mA
I <sub>sb</sub>	Stand-by Current	V <sub>IN</sub> =12V		200	370	μA
ON/OFF SEC	CTION		•			
V <sub>on</sub>	On State Input Voltage		2		5	V
V <sub>off</sub>	Off Stage Input Voltage				0.7	V
OUTPUT SE	CTION					
$V_{pdhv}$	PMOS Gate Drive High Voltage	V <sub>IN</sub> =12V		$V_{IN}$		V
$V_{phlv}$	PMOS Gate Drive Low Voltage	V <sub>IN</sub> =12V	V <sub>IN</sub> -10.5	V <sub>IN</sub> -8.5	V <sub>IN</sub> -6.5	V
$V_{ndhv}$	NMOS Gate Drive High Voltage	V <sub>IN</sub> =12V	6.5	8.5	10.5	V
$V_{ndlv}$	NMOS Gate Drive Low Voltage	V <sub>IN</sub> =12V		0		V
$V_{puv}$	PMOS Gate Voltage with UVLO Activated	V <sub>IN</sub> =V <sub>th</sub> -0.2	V <sub>IN</sub> -0.3			V
$V_{nuv}$	NMOS Gate Voltage with UVLO Activated	V <sub>IN</sub> =V <sub>th</sub> -0.2			0.3	V
t <sub>r</sub>	Rising Time <sup>(4)</sup>	V <sub>IN</sub> =12V, C <sub>load</sub> =2nF		200	500	ns
t <sub>f</sub>	Falling Time <sup>(4)</sup>	V <sub>IN</sub> =12V, C <sub>load</sub> =2nF		200	500	ns
MAXIMUM /	MINIMUM OVERLAP					
	Min. Overlap between diagonal switches <sup>(4)</sup>	f <sub>osc</sub> = 100kHz		0		%
	Max. Overlap between diagonal switches <sup>(4)</sup>	f <sub>osc</sub> = 100kHz		100		%
DELAY TIME						
	PDR_A/NDR_B <sup>(4)</sup>	RT=18kΩ		450		ns
	PDR_C/NDR_D <sup>(4)</sup>	RT=18kΩ	1/	450		ns

#### Note:

<sup>4.</sup> These parameters, although guaranteed, are not 100% tested in production.

### **Functional Description**

**UVLO:** The under-voltage lockout (UVLO) circuit guarantees stable operation of the IC's control circuit by stopping and starting it as a function of the VIN value. The UVLO circuit turns on the control circuit when VIN exceeds 5V. When VIN is lower than 5V, the IC's standby current is less than  $200\mu A$ .

**ENA:** Applying voltage higher than 2V to the ENA pin enables the operation of the IC. Applying voltage lower than 0.7V to the ENA pin disables the operation of the inverter.

**Soft-start:** The soft-start function requires that the  $S\_S$  pin is connected through a capacitor to GND. A soft-start circuit ensures a gradual increase in the input and output power. The capacitor connected to the  $S\_S$  pin determines the rate at which the duty ratio rises. It is charged by a  $6\mu A$  current source.

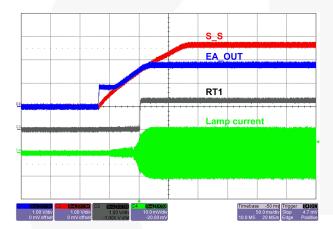


Figure 3. Soft-start during Initial Operation

Main Oscillator: The timing capacitors (CTs) are charged by the reference current source, which is formed by the timing resistor (RT). The timing resistor's voltage is regulated at 1.25V. The sawtooth waveform charges up to 2V. Once this voltage is reached, the capacitors begin discharging down to 0.5V. Next, the timing capacitors start charging again and a new switching cycle begins. The main frequency can be programmed by adjusting the RT and CT values. The main frequency can be calculated as shown below.

$$f_{\rm osc} = \frac{19}{32 \cdot RT \cdot CT} \tag{1}$$

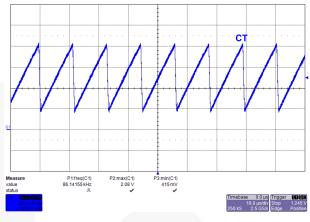


Figure 4. Main Oscillator Waveform

**Burst Oscillator and Burst Dimming**: The timing capacitors (BCTs) are charged by the reference current source, which is formed by the timing resistor (RT). The timing resistor's voltage is regulated at 1.25V. The sawtooth waveform charges up to 2V. Once this voltage is reached, the capacitors begin discharging down to 0.5V. Next the timing capacitors start charging again and a new switching cycle begins. The burst dimming frequency can be programmed by adjusting the RT and BCT values. The burst dimming frequency can be calculated as shown below.

$$f_{OSCB} = \frac{3.75}{96 \cdot RT \cdot CT} \tag{2}$$

To avoid visible flicker, the burst dimming frequency should be greater than 120Hz.

By comparing the input of BDIM pin with the 0.5~2V triangular wave of the burst oscillator the PWM pulses for burst dimming. The PWM pulse controls EA\_OUT's voltage by summing 85µA into the EA\_IN pin.

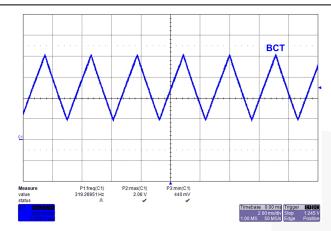


Figure 5. Burst Oscillator Waveform

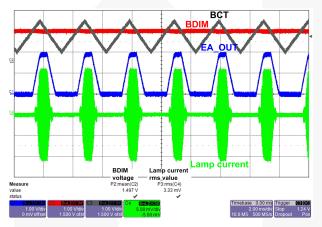


Figure 6. Burst Dimming

Open-Lamp Regulation and Open-Lamp Protection:

It is necessary to suspend power stage operation if an open lamp occurs because the power stage has high gain. When a voltage higher than 2V is applied to the OLR pin, the part enters regulation mode and controls the EA\_OUT voltage. This limits the lamp voltage by summing 105 $\mu$ A into the feedback node. At the same time, the OLP capacitor, connected to the OLP pin, is charged by the 1.4 $\mu$ A internal current source. Once it reaches 2.5V, the IC shuts down and all output is high.

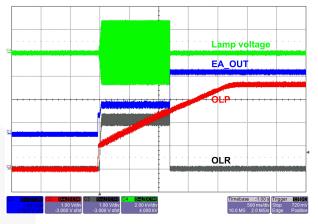


Figure 7. OLR Voltage during Striking Mode

**Output Drives**: The four output drives are designed so that switches A and B, C and D never turn on simultaneously. The OUTA-OUTB pair is intended to drive one half-bridge in the external power stage. The OUTC-OUTD pair drives the other half-bridge.

## **Timing Diagram**

The FAN7314A uses the half-bridge to drive CCFL.

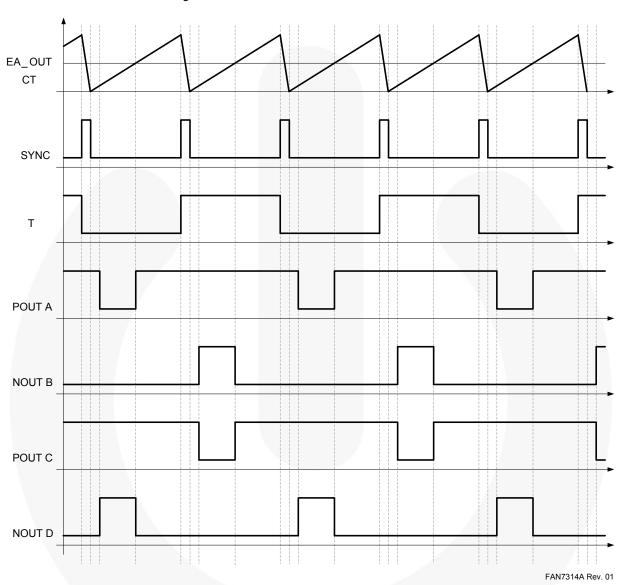


Figure 8. MOSFET Gate Drive Signal

## **Typical Application Circuit (LCD Backlight Inverter)**

Application	Device	Input Voltage Range	Number of lamps	
22-Inch LCD Monitor	FAN7314A	22V±5%	4	

#### 1. Features

- High-Efficiency Single-Stage Power Conversion
- P-N Half-Bridge Topology
- Reduces Required External Components
- Enhanced System Reliability through Protection Functions

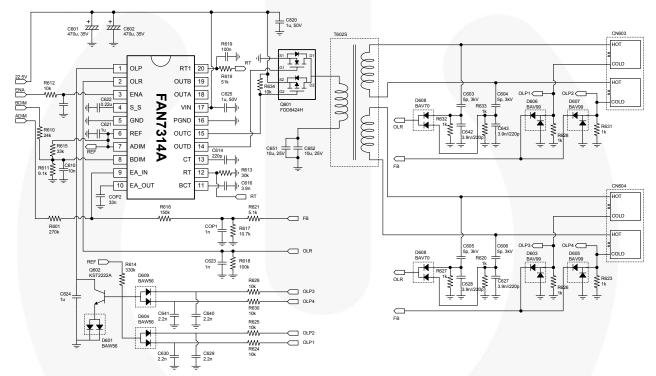


Figure 9. Typical Application Circuit

### 2. Transformer Specifications

- Supported by Clover Hitech (http://www.cloverhitech.com)
- PART NO : EEL-22W

Pin No.	Wire	Turns	Inductance	Leakage Inductance	Remarks
2 → 7	UTSC 0.1×12	19	83.0µH	16µH	
3 → 6	0130 0.1*12	19	63.0μΠ	Ιομπ	11:LI= 1\/
1 → 8	4 1151/1/0 040	2300	1.4H	280mH	1kHz, 1V
4 → 5	1 UEW 0.04Ω	2300	1.4П	20011117	

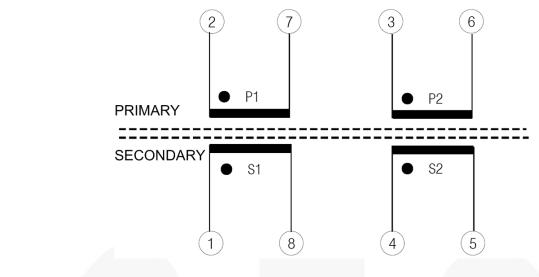


Figure 10. Schematic Diagram

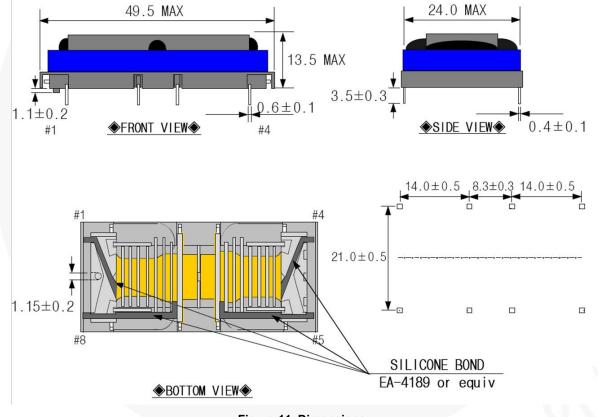


Figure 11. Dimensions

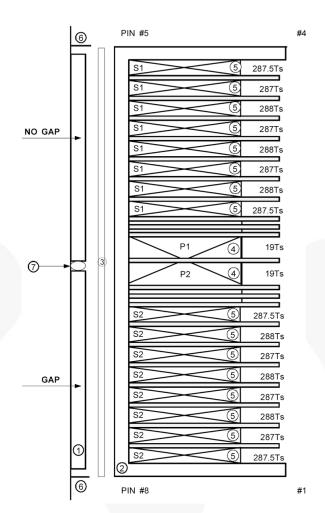


Figure 12. Section Diagram

### **Physical Dimensions** 13.00 12.60 11.43 В 9.50 10.65 7.60 10.00 7.40 10 1.27 PIN ONE 0.35 **INDICATOR** ⊕ 0.25 M C B A LAND PATTERN RECOMMENDATION 2.65 MAX SEE DETAIL A 0.33 0.20 △ 0.10 C 0.30 0.10 **SEATING PLANE** NOTES: UNLESS OTHERWISE SPECIFIED (R0.10) A) THIS PACKAGE CONFORMS TO JEDEC **GAGE PLANE** MS-013, VARIATION AC, ISSUE E (R0.10)B) ALL DIMENSIONS ARE IN MILLIMETERS. 0.25 C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS. D) CONFORMS TO ASME Y14.5M-1994 1.27 SEATING PLANE E) LANDPATTERN STANDARD: SOIC127P1030X265-20L -(1.40)F) DRAWING FILENAME: MKT-M20BREV3 DETAIL A

Figure 13. 20-SOIC Package

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Datasheet Identification	Product Status	Definition
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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